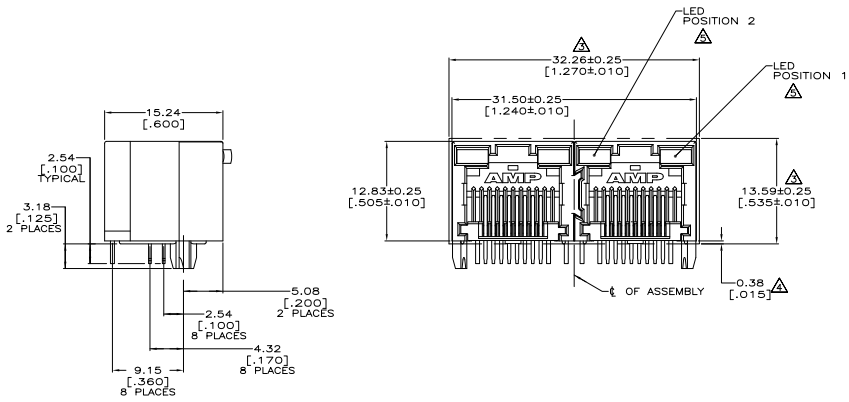
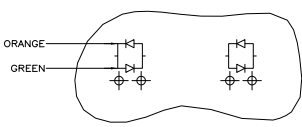


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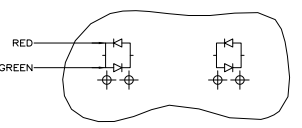
REV	DATE	DESCRIPTION	BY	CHK	APP
AA	22				
A		REV PER EC 0511-0201-04	13AN2005	JA	SF
AT		REVISED PER EC0-09-024927	090909	KK	AEG



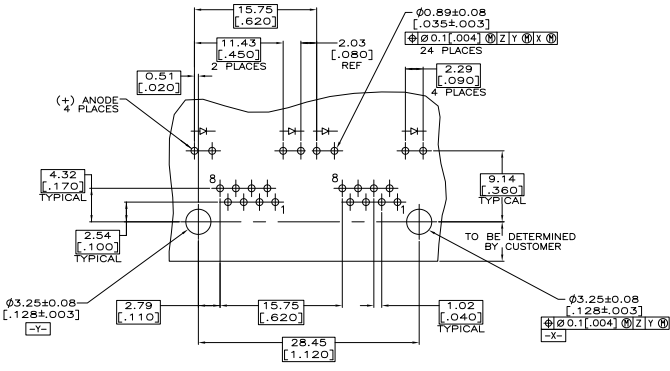
- MATERIAL:**
 HOUSING - HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0.
 TERMINALS - .36[.014] THICK PHOS BRONZE PLATED WITH 3.85µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27µm [0.00050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [0.00050] MINIMUM THICK NICKEL.
 LIGHT EMITTING DIODE (LED) - DIFFUSED EPOXY LENS, 0.51 x 0.51 [0.020 x .020] CARBON STEEL WIREFRAME LEADS PREPLATED WITH 8.89 µm [0.0003500] THICK Sn/Cu OVER 2.03 µm [0.00080] THICK Ag OVER 1.02µm [0.00040] THICK Cu OVER 3.56 µm [0.00140] THICK Ni OVER 1.02µm [0.00040] Cu UNDERPLATE.
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 6B, SUBPART F.
 - SUGGESTED PANEL OPENING DIMENSIONS.
 - SUGGESTED CLEARANCE BETWEEN BOTTOM OF CONNECTOR AND BOTTOM PANEL OPENING.
 - SEE TABLE FOR COLOR OF LEDS AND NUMBER REQUIRED.
 - THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.
 - OBsolete PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI



LED CURRENT DIAGRAM
 5406534-7 ONLY
 OBSOLETE



LED CURRENT DIAGRAM
 5406534-4 ONLY
 OBSOLETE



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
 (COMPONENT SIDE)

INDICATOR COLOR FOR EACH HOUSING	POSITION 2	POSITION 1	PART NUMBER
GREEN/RED	GREEN	RED	5406534-4
ORANGE/GREEN	ORANGE	GREEN	5406534-7
YELLOW	YELLOW	YELLOW	5406534-6
GREEN	GREEN	GREEN	5406534-8
YELLOW	YELLOW	YELLOW	5406534-3
	GREEN	GREEN	5406534-2

INDICATIONS	SYMBOLS	DEFINITIONS
ENCLOSURE	□	ENCLOSURE
WELDING	⊕	WELDING
PLATING	⊖	PLATING
FINISH	⊙	FINISH
ETCH	⊘	ETCH
DRILL	⊚	DRILL
REWORK	⊛	REWORK
REVISION	△	REVISION